PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:			NEW ASSIGNMENT	
NATURE OF CONVEY	ANCE:		ASSIGNMENT	
CONVEYING PARTY	DATA			
		N	lame	Execution Date
Teradyne, Inc.				11/30/2005
RECEIVING PARTY D	ΑΤΑ			
Name:	Amphenol Cor	porati	on	
Street Address:	358 Hall Avenu	ue		
City:	Wallingford			
State/Country:	CONNECTICL	JT		
Postal Code:	06492			
PROPERTY NUMBER	RS Total: 1			
Property Ty	/pe		Number	
Application Number:	1	12477	578	1578
CORRESPONDENCE	DATA			12477578
Fax Number:	(202)772-	-5858		0
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Phone: Email:	20277258			5
Correspondent Name:	stout@bla Blank Ro			CH
Address Line 1:			-· oshire Avenue, N.W.	
Address Line 2:	Watergate	е		
Address Line 4:	Washingt	on, D	ISTRICT OF COLUMBIA 20037	
ATTORNEY DOCKET	NUMBER:		124315.0757	
NAME OF SUBMITTE	R:		Peter S. Weissman	
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INTELLECTUAL PROPERTY ASSIGNMENT AGREEMENT AND LICENSE AGREEMENT

This Intellectual Property Assignment Agreement and License Agreement (this "<u>Agreement</u>") is made this 30th day of November, 2005 (the "<u>Effective Date</u>"), by and between Teradyne, Inc., a Massachusetts corporation ("<u>Assignor</u>") and Amphenol Corporation, a Delaware corporation ("<u>Buyer</u>").

RECITALS

WHEREAS, Buyer and Teradyne, Inc. have entered into an Asset and Stock Purchase Agreement dated October 10, 2005 (the "<u>Purchase Agreement</u>"), pursuant to which Buyer shall purchase certain assets related to the Business (capitalized terms used herein and not otherwise defined shall have the respective meanings set forth in the Purchase Agreement);

WHEREAS, pursuant to the Purchase Agreement, Assignor desires to transfer and assign to Buyer, and Buyer desires to accept the transfer and assignment of all of Assignors' right, title and interest in and to the Purchased Intellectual Property including that Intellectual Property listed on <u>Schedule A</u> attached hereto, and to license to Buyer certain trademark rights for the use of those marks listed on <u>Schedule C</u> subject to certain conditions as identified herein;

WHEREAS, Buyer is willing to grant a limited license to Assignor with respect to certain Intellectual Property set forth on <u>Schedule B</u> transferred pursuant to the Purchase Agreement for internal use and for use in connection with its Products;

NOW, THEREFORE, for valuable consideration, the sufficiency of which is hereby mutually acknowledged, the parties agree as follows:

1. THE ASSIGNMENT OF INTELLECTUAL PROPERTY RIGHTS BY ASSIGNOR TO BUYER

Pursuant and subject to the Purchase Agreement, Assignor does hereby transfer, assign, convey and deliver to Buyer, and its Affiliates, successors and assigns, and Buyer hereby accepts the transfer and assignment of all of Assignor's right, title and interest in, to and under the Purchased Intellectual Property including the Intellectual Property listed on <u>Schedule A</u> attached hereto, and including, to the extent included therein: (i) all of the goodwill associated therewith; (ii) all rights to recover for infringement associated therewith whether arising prior to or subsequent to the date of this Assignment; (iii) all inventions disclosed therein and all divisionals, continuations, continuations-in-part, substitutes, renewals, reissues, reexaminations or other applications which have been or may be filed in the United States or any foreign country on any of said inventions, (iv) all patents which may be granted therefore throughout the world, including the right to file applications and obtain patent grants, utility models, industrial models and designs for any of said inventions in its own name throughout the world, and (v) all rights of priority, all rights to publish cautionary notices reserving ownership of said inventions, and all rights to register said inventions in appropriate registries.

To the extent that this Agreement is not acceptable for purposes of recording in a necessary office to indicate transfer to Buyer of any of the Purchased Intellectual Property, including the Intellectual Property listed on <u>Schedule A</u>, then in addition to this Agreement and without limiting its obligations under Section 4, for a period of one hundred eighty (180) days after the Closing or such other time period reasonably necessitated or required by local jurisdiction in question to achieve the transfer, Assignor and its Affiliates agree to execute individual assignments of all of the Purchased Intellectual Property including the Intellectual Property listed on <u>Schedule A</u> attached hereto, with respect to those individual countries where this Agreement is not acceptable for recording, which assignments shall be executed, and, where required, notarized and/or legalized apostille, on behalf of Assignor. The form of assignment or transfer shall be that used customarily in the jurisdiction in question to achieve the transfer on the terms set forth above. Buyer and Assignor shall each be responsible for fifty percent (50%) of the costs of filing or recording the assignments of all of the Purchased Intellectual Property in a necessary office to indicate transfer to Buyer.

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2. THE LICENSE OF INTELLECTUAL PROPERTY RIGHTS BY BUYER TO ASSIGNOR

Buyer hereby grants to Assignor and its Affiliates, and their permitted successors and assigns, a limited, non-exclusive, perpetual, irrevocable, worldwide, royalty-free, non-sublicensable license under the Intellectual Property Rights listed in <u>Schedule B</u>, to design, have designed, use, have used, manufacture, have manufactured, market, sell, offer to sell, distribute (directly and indirectly), import and export:

- (i) Assignor's and its Affiliates', current and future end products and/or subassemblies which contain a printed circuit board, backpanel, backplane, or equivalent structure;
- (ii) printed circuit boards, backpanels, backplanes, or equivalent structures, for use only in Assignor's and its Affiliates' current and future products, sold or provided as spare, repair or replacement parts;
- (iii) products used internally by Assignor and its Affiliates, or used internally by subcontractors, to manufacture products for Assignor and its Affiliates; and
- (iv) in the case of DesignLink software and its intellectual property identified in <u>Schedule</u> <u>B</u>, to be used internally by Assignor and its Affiliates or externally by their customers,

which, except for the limited license granted herein, would infringe a right conferred by the Intellectual Property Rights identified on <u>Schedule B</u>.

The rights granted hereunder are not intended to nor shall be they be construed to minimize or limit the noncompetition restrictions contained in Section 5.05(a) of the Purchase Agreement.

Assignor agrees that Buyer has no obligation to maintain or continue the prosecution of any provisional or pending patent applications listed in <u>Schedule B</u>; provided that, at least ninety (90) days before allowing any such provisional or pending applications to lapse, Buyer will provide notice to Assignor, whereupon Assignor will have the option to maintain or continue prosecution of such provisional or pending applications at Assignor's expense. In such an event,

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Assignor will assume all ownership rights in the provisional or pending applications and Buyer agrees to assign such ownership rights to Assignor; provided that, in such event Assignor shall grant Buyer a license under such Patent substantially similar to the license granted to Assignor in this Section 2.

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Assignor acknowledges that a breach of the license granted by Buyer in this Section 2 may cause the Buyer irreparable damage, for which the award of damages alone may not be adequate compensation and the Buyer is therefore entitled to seek injunctive relief to enjoin the Assignor from violation of those provisions. Such injunctive relief remedy shall be cumulative and not exclusive and the Buyer is entitled to seek any other relief available to it at law or in equity.

3. THE LICENSE OF CERTAIN TRADEMARK RIGHTS BY ASSIGNOR TO BUYER

For a term of not more than two (2) years from the Effective Date, Assignor hereby grants to Buyer, and its Affiliates, successors and assigns, a non-exclusive, worldwide, royalty-free, non-transferable right and license to the rights Assignor has to the mark set forth on <u>Schedule C</u> (hereinafter "Licensed Mark") only on products formerly offered by Assignor's TCS division and only in conjunction with the word "Amphenol" (for example "an Amphenol TCS product" or "an Amphenol product formerly manufactured by TCS"). Buyer may continue to use Assignor's existing inventory of stationary, business cards, marketing literature, preprinted documents, and similar materials that are branded only with the Licensed Mark but not any other trademark of Assignor (for example, excluding any materials branded with the word "Teradyne") until such existing supply is exhausted. This license does not extend to the use by Buyer of the Licensed Mark on a stand-alone basis.

Buyer agrees that its use of the Licensed Mark will be in accordance with applicable law and Assignor's reasonable policies regarding advertising and trademark usage as published from time to time by Assignor. Buyer agrees to use the Licensed Mark in a manner reasonably consistent with the established standards of quality and goodwill associated with the Licensed Mark prior to the Effective Date. If, in Assignor's sole discretion, Assignor reasonably determines that Buyer's use of the Licensed Mark harms, tarnishes, dilutes or damages the goodwill associated with the Licensed Mark, Assignor shall notify Buyer in writing and Buyer shall correct any such use within ten (10) business days of receipt of such notice or Assignor may unilaterally terminate this license in the Licensed Mark.

In order to verify compliance with this Section 3 of this Agreement, Assignor may from time to time require that Buyer provide samples of Buyer's marketing materials that bear the Licensed Mark.

4. FURTHER ASSURANCES

Assignor and Buyer hereby further agree, each for itself and its successors, assigns, and legal representatives, to execute upon request any other lawful documents and likewise to perform any other lawful acts that are necessary to secure fully the aforesaid rights, titles, and interests in and to said Purchased Intellectual Property.

5. EXECUTION OF COUNTERPARTS

This Assignment may be executed in one or more counterparts, each of which will be deemed to be an original copy of this Assignment and all of which, when taken together, will be deemed to constitute one and the same agreement. The exchange of copies of this Assignment and of signature pages by facsimile transmission shall constitute effective execution and delivery of this Assignment as to the parties and may be used in lieu of the original Assignment for all purposes. Signatures of the parties transmitted by facsimile shall be deemed to be their original signatures for all purposes.

6. ENTIRE AGREEMENT; AMENDMENT

Together with the Purchase Agreement and the Ancillary Agreements (as defined therein), this document contains the entire agreement relating to the subject matter contained herein and supersedes all prior or contemporaneous agreements, written or oral, between the parties. This Agreement may not be modified except by written document signed by an authorized representative of each party.

7. PRECEDENCE

This Agreement is executed and delivered pursuant to, and is subject to, the Purchase Agreement. In the event of any conflict between the terms of the Purchase Agreement and the terms of this Agreement, the terms of the Purchase Agreement shall prevail.

8. SEVERABILITY

Any provision of this Agreement which is invalid, illegal or unenforceable in any jurisdiction shall, as to that jurisdiction, be ineffective to the extent of such invalidity, illegality or unenforceability, without affecting in any way the remaining provisions hereof in such jurisdiction or rendering that or any other provision of this Agreement invalid, illegal or unenforceable in any other jurisdiction.

9. GOVERNING LAW

This Agreement shall be construed in accordance with and governed by the laws of the State of New York, without regard to the conflicts of law rules of such state.

10. ASSIGNMENT

This Agreement and the rights and licenses hereunder granted are not assignable by Assignor without the written consent of Buyer except, with reasonable notice to Buyer: (i) to an Affiliate of Assignor; (ii) in connection with an assignment of all or substantially all of the assets of Assignor or a business division of Assignor.

[REMAINDER OF PAGE LEFT INTENTIONALLY BLANK]

IN WITNESS WHEREOF, the parties have caused this ASSIGNMENT to be duly executed and delivered as of November _____, 2005.

ASSIGNOR:

TERADYNE, INC.

Alberty By: Name;

Title:

State of <u>MASSAchusetts</u>) ss.: County of <u>Suffe</u>[<u>k</u>]

On this <u>30</u> day of <u>NO3</u>, 2005, before me, personally appeared <u>Gregory Bereford VP\$(F0 of</u> Teradyne, Fnc, personally known to me (or proved to me on the basis of satisfactory evidence consisting of _____) to be the person whose name is subscribed to the within instrument and acknowledged to me that he executed the same in his authorized capacity and that by his signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

Witness my hand and official seal. Mary Elandutto Mard Notary Fublic 6/25/2010

MARY ELIZABETH MACDONALD Notary Public **Commonwealth of Massachusetts** My Commission Expires Jun 25: 2010

BUYER:

AMPHENOL CORPORATION

By: _____ Name: Title: State of _____) ss.: County of _____)

On this	day of	, 2005, b	efore me,
personally appeared		, of	
personally known to	me (or proved	to me on the basi	s of satisfactory
evidence consisting of) to be the	
name is subscribed to	o the within ins	strument and ackr	lowledged to me
that he executed the	same in his auf	horized capacity	and that by his
signature on the instr	ument the pers	ion, or the entity u	pon behalf of
which the person act			

Witness my hand and official seal.

Notary Public

SIGNATURE PAGE TO INTELLECTUAL PROPERTY ASSIGNMENT

IN WITNESS WHEREOF, the parties have caused this ASSIGNMENT to be duly executed and delivered as of _____, 2005.

ASSIGNOR:

TERADYNE, INC.

(State of _____) ss.: (County of _____)

By: ____ Name: Title:

On this _____ day of _____, 2005, before me, personally appeared ______, of _____, personally known to me (or proved to me on the basis of satisfactory avidence approximation of evidence consisting of ______) to be the person whose name is subscribed to the within instrument and acknowledged to me that he executed the same in his authorized capacity and that by his signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

Witness my hand and official seal

Notary Public

BUYER:

AMPHENOL CORPORATION

By: 1 imothy & Cohane

Title: Executive V.P.

(State of <u>Connecticut</u>) ss.: Wallingford (County of <u>New Haven</u>)

On this _____ day of _____, 2005, before me, personally appeared TIMOTHY F. COHANE, of AMPHENCL CORPORATION By: / personally known to me (or proved to me on the basis of satisfactory Name: Timothy F. Cohane-vidence consisting of ///A.) to be the person whose name is subscribed to the within instrument and acknowledged to me that he executed the same in his authorized capacity and that by his signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

Witness my hand and official seal

Mary ann apomes Notary Public MARY ANN AFTOSMES

My Commission Expires: September 30, 2008

[SIGNATURE PAGE TO INTELLECTUAL PROPERTY ASSIGNMENT]

SCHEDULE A

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Intellectual Property Assigned by Assignor to Buyer

Patents:

Case #	Country	Patent #	Issue Date	Filing Date	Status	
0007	CA	1274887	02-Oct-1990	07-Jan-1987	Granted	
Title:	DAUGHTER	BOARD BACKPLA	NE ASSEMBLY			
0007	JP	1587364		10-Jan-1987	Granted	
Title:	DAUGHTER	BOARD BACKPLA	NE ASSEMBLY			
0007	US	4686607	11-Aug-1987	08-Jan-1986	Granted	
Title:	DAUGHTER	BOARD BACKPLA	NE ASSEMBLY			

0008	CA	1312146	29-Dec-1992	22-Sep-1989	Granted	
		CIRCUIT BOARDS				CONTROL
0008	DE	4002025	11-Sep-1997	31-Jan-1990	Granted	
Title:	PRINTED	CIRCUIT BOARDS	WITH IMPROVED	ELECTRICAL	CURRENT	CONTROL
		2642255		26-Jan-1990		
Title:	PRINTED	CIRCUIT BOARDS	WITH IMPROVED	ELECTRICAL	CURRENT	CONTROL
0008	GB	2229042		26-Jan-1990	Granted	
Title:	PRINTED	CIRCUIT BOARDS	WITH IMPROVED	ELECTRICAL	CURRENT	CONTROL
	US	5038252	06-Aug-1991	26-Jan-1989	Granted	
Title:	PRINTED	CIRCUIT BOARDS	WITH IMPROVED	ELECTRICAL	CURRENT	CONTROL
1						

	0009	CA	1236187	03-May-1988	18-Nov-1986	Granted
	Title:	BACKPLANE-DA	UGHTER BOA	RD CONNECTOR		
Ì	0009	US	4659155	21-Apr-1987	19-Nov-1985	Granted
	Title:	BACKPLANE-DA	UGHTER BOA	RD CONNECTOR		

0010 Title:	US ELECTRICAL	4871321 CONNECTOR	03-Oct-1989	22-Mar-1988	Granted
0012	DE	4411187	05-Oct-2000	30-Mar-1994	Granted
Title:	POWER CON	NECTOR			
0012	FR	2703518	20-Sep-1996	31-Mar-1994	Granted
Title:	POWER CON	NECTOR			
0012	JP	2706619	09-Oct-1997	31-Mar-1994	Granted
Title:	POWER CON	NECTOR			
0012	US	5360349	01-Nov-1994	31-Mar-1993	Granted
	POWER CON	NECTOR			

Case #	Country	Patent #	Issue Date	Filing Date	Status
0016	US	4909743	20-Mar-1990	14-Oct-1988	Granted
	ELECTRICAL				
0017	CA	1245733	29-Nov-1988	16-Aug-1985	Granted
	BACKPLANE			-	
0057	CA	2119500	24-Nov-1998	21-Mar-1994	Granted
Title:	SHIELDED EL	ECTRICAL CONNE			
0057	DE		•	23-Mar-1994	Granted
		ECTRICAL CONNE			
0057	FR			29-Mar-1994	Granted
		ECTRICAL CONNE		01 1.1 1004	One of the second secon
0057	FR	2707045		01-Jul-1994	Granted
		ECTRICAL CONNE		25-Mar-1994	Granted
0057	GB	2276989 ECTRICAL CONNE		2J-Widl-1994	Glaned
0057	JP	2739922	23-Jan-1998	04-Apr-1994	Granted
	••	ECTRICAL CONNE		04-Api-1774	Granded
0057	US			02-Apr-1993	Granted
		ECTRICAL CONNE		02 mpi 1990	Granda
0057	US	5605476	25-Feb-1997	07-Jun-1995	Granted
		ECTRICAL CONNE			
0057	US	5484310	16-Jan-1996	06-Mar-1995	Granted
		ECTRICAL CONNE	ECTOR		
0057	US	5607326	04-Mar-1997	17-Jun-1996	Granted
Title:	SHIELDED EL	ECTRICAL CONNE	ECTOR		
·····					
1009	US	5704793	06-Jan-1998	17-Apr-1995	
Title:	HIGH SPEED,	HIGH DENSITY CO		ELECTRONIC	SIGNALS
1009	US	5820397	13-Oct-1998	21-May-1997	
Title:	HIGH SPEED,	HIGH DENSITY CO	DNNECTOR FOR	ELECTRONIC	SIGNALS
1011	DE	69510956-1	21-Jul-1999	04-Dec-1995	Granted
		CUIT BOARD CON			
1011		00803136		04-Dec-1995	Granted
		CUIT BOARD CON		04 D 1000	
1011	FR	00803136	21-Jul-1999	04-Dec-1995	Granted
E		CUIT BOARD CON		04 Dec 1000	Cuented
1011	GB	00803136	21-Jul-1999	04-Dec-1995	Granted
1		CUIT BOARD CON	NECTORS 21-Jan-1997	13-Jan-1995	Granted
1011	US DRINTED CIR	5595490		13-1411-1993	At differ
1 itle:	PRINTED CIR	CUIT BOARD CON	NECTORS	·····	
1016	DD	0000117	05 1.1 2000	04-Mar-1996	Granted
1016	DE SUBEACE MO	0829117	05-Jul-2000		VI aifted
1		UNTED ELECTRIC	05-Jul-2000	K 04-Mar-1996	Granted
1016 Titlet	GB	0829117 OUNTED ELECTRIC			Granicu
1016	US	6152742	28-Nov-2000	31-May-1995	Granted
		UNTED ELECTRIC		•	Station
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Case #	Country	Patent #	Issue Date	Filing Date	Status	
1016	US	6042386	28-Mar-2000	18-Sep-1998	Granted	
Title:	SURFACE MOU	JNTED ELECTR	ICAL CONNECTO)R		
1041	US	5672064	30-Sep-1997	21-Dec-1995	Granted	
Title:	STIFFENER FO	RELECTRICAL	CONNECTOR			
1054	US	5690504	25-Nov-1997	13-May-1996	Granted	·····
Title:	PLASTIC GUID	E PIN WITH STE	EEL CORE			
1056	DE	69722392.2	28-May-2003	06-Feb-1997	Granted	
	Electrical Conne	ctor Assembled F				
1056	EP	0890201	28-May-2003	06-Feb-1997	Granted	
		ctor Assembled F			a	
1056	FR	0890201	28-May-2003	06-Feb-1997	Granted	
		ctor Assembled F		0C F-1 1007	Created	
1056	GB	0890201	28-May-2003	06-Feb-1997	Granted	
		ctor Assembled F	3 25-Aug-2003	06-Feb-1997	Granted	
1056	IT Electrical Conne	ctor Assembled F		00-1.00-1321	Granicu	
1056	KR	319306	18-Dec-2001	06-Feb-1997	Granted	
		ector Assembled F				
1056	US	5702258	30-Dec-1997	28-Mar-1996	Granted	
		ctor Assembled F				
1056	US I	5860816	19-Jan-1999	24-Nov-1997	Granted	
	** -	ctor Assembled F	rom Wafers			

Γ	1085	US	5885095	23-Mar-1999	28-May-1996	Granted
	Title:	Electrical Con	nector Assembly Wit	h Mounting Harc	Iware And Protecti	ive Cover

1091	DE	69814123D	02-May-2003	15-Jan-1998	Granted
Title:	High Speed,	High Density Electrica	l Connector		
1091	EP	1021854	02-May-2003	15-Jan-1998	Granted
Title:	High Speed,	High Density Electrica	l Connector		
1091	FR	1021854	02-May-2003	15-Jan-1998	Granted
Title:	High Speed,	High Density Electrica	I Connector		
1091	GB	1021854	02-May-2003	15-Jan-1998	Granted
Title:	High Speed,	High Density Electrica	I Connector		
1091	MX	212198	17-Dec-2002	15-Jan-1998	Granted
Title:	High Speed	l, High Density Electric	cal Connector		
1091	US	5993259	30-Nov-1999	07-Feb-1997	Granted
Title:	High Speed,	High Density Electrica	l Connector		
1091	US	6238245	29-May-2001	26-Aug-1999	Granted
Title:	High Speed,	High Density Electrica	I Connector		

Case #	Country	Patent #	Issue Date	Filing Date	Status
1103	DE		15-May-2002		Granted
Title:	HIGH SPEED, HIG	GH DENSITY E	LECTRICAL CO	NNECTOR	
1103	EP	1021855		15-Jan-1998	Granted
Title:	HIGH SPEED, HIC	GH DENSITY E	LECTRICAL CO	NNECTOR	
1103	FR	1021855	15-May-2002	15-Jan-1998	Granted
Title:	HIGH SPEED, HIC	GH DENSITY E	LECTRICAL CO	NNECTOR	
1103	GB	1021855	15-May-2002	15-Jan-1998	Granted
Title:	HIGH SPEED, HIC	GH DENSITY E	LECTRICAL CO	NNECTOR	
1103	IE	1021855	15-May-2002	15-Jan-1998	Granted
Title:	HIGH SPEED, HIG	GH DENSITY E	LECTRICAL CO	NNECTOR	
1103	MX	212197	17-Dec-2002		Granted
Title:	HIGH SPEED, HIG	GH DENSITY E	LECTRICAL CO	NNECTOR	
1103	NL	1021855	15-May-2002		Granted
Title:	HIGH SPEED, HIG	GH DENSITY E	LECTRICAL CO	NNECTOR	
1103	SE	1021855		15-Jan-1998	Granted
Title:	HIGH SPEED, HIG	GH DENSITY E	ELECTRICAL CO	NNECTOR	
1103	US	5980321	09-Nov-1999		Granted
Title:	HIGH SPEED, HIG	GH DENSITY E	ELECTRICAL CO	NNECTOR	
1103	US	6299483	09-Oct-2001	26-Aug-1999	Granted
Title:	HIGH SPEED, HIG	GH DENSITY E	ELECTRICAL CO	NNECTOR	
1					
1151	CN	99813967 X	(27-Apr-2005	01-Jun-2001	Granted
Title:	Printed Circuit Boa				
1151	MX	223480	13-Oct-2004	01-Jun-2001	Granted

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1 1 1	(J1	1211	22012201.31	11 1 1 1 1 1 1 0 0 0 V		
	Title:	Printed Circuit	Board and Method fo	or Fabricating S	uch Board	
1	151	MX	223480	13-Oct-2004	01-Jun-2001	Granted
	Title:	Printed Circuit	t Board and Method fo	or Fabricating S	luch Board	
1	151	US	6181219	30-Jan-2001	02-Dec-1998	Granted
	Title:	Printed Circuit	t Board and Method fo	or Fabricating S	uch Board	
1	151	EP	1138180	24-Mar-2004	02-Dec-1999	Granted
	Title:	Printed Circuit	t Board and Method fo	or Fabricating S	luch Board	
I	151	FR	1138180	TBD	02-Dec-1999	Granted
	Title:	Printed Circui	t Board and Method fo			
1	151	NE	1138180	TBD	02-Dec-1999	Granted
	Title:	Printed Circui	t Board and Method fo	or Fabricating S	Such Board	
1	151	DE	69915874.5	TBD	02-Dec-1999	Granted
	Title:	Printed Circuit	t Board and Method fo	or Fabricating S	Such Board	

1154 CN 1127780 12-Nov-2003 24-May-2001 Granted Title: ELECTRICAL CONNECTOR 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR						
1154 EP 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 31-Mar-2004 22-Nov-1999 Granted 1154 DE 69916100 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 31-Mar-2004 22-Nov-1999 Granted 1154 FR 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2004 22-Nov-1999 Granted 1154 GB 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted	1154	CN	1127780	12-Nov-2003	24-May-2001	Granted
Title: ELECTRICAL CONNECTOR 1154 DE 69916100 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 1133812 31-Mar-2004 22-Nov-1999 Granted 1154 FR 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 1154 GB 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted	Title:	ELECTRICAL CONN	VECTOR			
1154 DE 69916100 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 31-Mar-2004 22-Nov-1999 Granted 1154 FR 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 1154 GB 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted	1154	EP	1133812	31-Mar-2004	22-Nov-1999	Granted
Title: ELECTRICAL CONNECTOR 1154 FR 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 1154 GB 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 1154 US 6530790 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 1154 US 6530790 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted	Title:	ELECTRICAL CONN	VECTOR			
1154 FR 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 1133812 31-Mar-2004 22-Nov-1999 Granted 1154 GB 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted	1154	DE	69916100	31-Mar-2004	22-Nov-1999	Granted
Title: ELECTRICAL CONNECTOR 1154 GB 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted 1154 US 6537087 25-Mar-2003 25-Jan-2002 Granted	Title:	ELECTRICAL CON	NECTOR			
1154 GB 1133812 31-Mar-2004 22-Nov-1999 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 11-Mar-2003 25-Jan-2002 Granted	1154	FR	1133812	31-Mar-2004	22-Nov-1999	Granted
Title:ELECTRICAL CONNECTOR1154US653079011-Mar-200324-Nov-1998GrantedTitle:ELECTRICAL CONNECTOR1154US653708725-Mar-200325-Jan-2002Granted	Title:	ELECTRICAL CO	NECTOR			
1154 US 6530790 11-Mar-2003 24-Nov-1998 Granted Title: ELECTRICAL CONNECTOR 1154 US 6537087 25-Mar-2003 25-Jan-2002 Granted	1154	GB	1133812	31-Mar-2004	22-Nov-1999	Granted
Title:ELECTRICAL CONNECTOR1154US653708725-Mar-200325-Jan-2002Granted	Title:	ELECTRICAL CO	NECTOR			
1154 US 6537087 25-Mar-2003 25-Jan-2002 Granted	1154	US	6530790	11-Mar-2003	24-Nov-1998	Granted
	Title:	ELECTRICAL CON	NECTOR			
Title: ELECTRICAL CONNECTOR	1154	US	6537087	25-Mar-2003	25-Jan-2002	Granted
	Title:	ELECTRICAL CON	NECTOR			

Case #	Country	Patent #	Issue Date	Filing Date	Status
1220	US Differential Signal El	6379188	30-Apr-2002	24-Nov-1998	Granted
1220	Differential Signal Ele US D1 Differential Signal Ele	6503103	07-Jan-2003	22-Jun-2000	Granted
1220	US D2 Differential Signal Ele	6554647	29-Apr-2003	22-Jun-2000	Granted
1220	US D3 Differential Signal El	6607402	19-Aug-2003	08-Apr-2002	Granted
L					
1221	US	6565387	20-May-2003	30-Jun-1999	Granted
1221	Modular Electrical Co MX	228505	15-Jun-2005	19-Dec-2001	Granted
Title:	Modular Electrical Co	onnector and C	connector System		
1227	CN	1139151	-Feb-2004	22-Nov-1999	Granted
1227	Electrical Connector EP	1145386	24-Mar-2004	22-Nov-1999	Granted
1227	Electrical Connector	6394822	28-May-2002	24-Nov-1998	Granted
Title:	Electrical Connecto	r with Impeda	nce Balancing Sec	10115	
1228 Title:	US Electrical Connector	6152747 with End of R	28-Nov-2000 ow Contacts to Eq	24-Nov-1998 ualize Performa	Granted nce
1284 Title:	US Multi-Connection V	6388208 /IA with Elect	14-May-2002 rically Isolated Se	23-Jul-1999 gments	Granted
1285 Title:	US SPLIT VIA SURFAC	6137064 CE MOUNT C	24-Oct-2000 CONNECTOR AN	23-Jul-1999 D RELATED TI	Granted ECHNIQUES
1302 Title:	US DIRECT INNER L	6593535 AYER INTER	15-Jul-2003 CONNECT FOR	26-Jun-2001 A HIGH SPEED	Granted D PRINTED CIRCUIT BOARD
1325 Title:	US Differential Signal	6293827 Electrical Con	25-Sep-2001 inector	03-Feb-2000	Granted
1326 Title:	US HIGH SPEED PRES	6517360 SURE MOUN	11-Feb-2003 IT CONNECTOR	11-Jun-2001	Granted
1327 Title	DE CONNECTOR WIT	1256145 H EGG-CRAT	24-Nov-2004	30-Jan-2001	Granted
1327	EP CONNECTOR WIT	1256145	24-Nov-2004	30-Jan-2001	Granted
1327	FR CONNECTOR WIT	1256145	24-Nov-2004	30-Jan-2001	Granted
1327	TW CONNECTOR WIT	156867	26-Sep-2002	18-May-2001	Granted
1327 Title:	US CONNECTOR WI	6506076	14-Jan-2003	31-Jan-2001	Granted

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Case #	Country	Patent #	Issue Date	Filing Date	Status
1380 Title:	US Methods and A	6639154 pparatus For Form	28-Oct-2003 ing A Connection	10-Oct-2000 n between A Circu	Granted uit Board And A Connector
1383	US	6352436	05-Mar-2002	29-Jun-2000	Granted
1388	US	essure Connection 6520686 aratus for Forming	18-Feb-2003 a Fiber Optic Co	09-Nov-2000	Granted
1388	US	6616342	09-Sep-2003	01-Oct-2002	Granted
Title:	Method and App	aratus for Forming	a Fiber Optic Co	nnection	
1393 Title:	US Methods and Ar	6452379 oparatus for Connec	17-Sep-2002 ting to A Signal	20-Oct-2000 Launch	Granted
1393 Title:	US I	6717398 opparatus for Conne	06-Apr-2004	22-Jul-2002	Granted
1394	US	6511229	28-Jan-2003	21-Dec-2000	Granted
Title:		pparatus for Contr			ace
1395 Title:	US Optical Backp	6516105 ane Assembly and	04-Feb-2003 Method of Maki	10-Oct-2000 ng Same	Granted
1396	US	6619854	16-Sep-2003	31-Jan-2001	Granted
Title:		Cleaning An Optic		n Optical Connec	tion System
1405 Title:	US	6588943 Connector Module	08-Jul-2003	07-Aug-2000	
1410	EP	1360533	23-Mar-2005	30-Jan-2002	Granted
Title.		Selectively Exposin			
1410	DE	60203372	23-Mar-2005	30-Jan-2002	Granted
Title:	Techniques for	r Selectively Expos		ng An Optical Inte	erface Using Film
1410	FR	1360533	23-Mar-2005	30-Jan-2002	Granted
Title:		r Selectively Expos	ing and Protectin	ng An Optical Inte	rface Using Film
1410	GB	1360533	23-Mar-2005	30-Jan-2002	Granted
Title:	Techniques fo	r Selectively Expos	ing and Protection	ng An Optical Inte	erface Using Film
1410	US	6547444	15-Apr-2003	31-Jan-2001	Granted
Title:	Techniques fo	r Selectively Expos	ing and Protecti	ng An Optical Into	erface Using Film
1437	TW	205664	26-Oct-2004	15-Jan-2002	Granted
Title:	Connector Mold	ling Method and Sh	ielded Waferize	d Connector Made	e Therefrom
1437	US	6409543	25-Jun-2002	25-Jan-2001	Granted
Title:	Connector Mold	ling Method and Sh	ielded Waferize	d Connector Mad	e I herefrom
1437	US	6602095	05-Aug-2003	24-Apr-2002	Granted
Title:	Connector Mc	Iding Method and	Shielded Waferiz	ed Connector Ma	de Ineretrom
1447	US	5945838	31-Aug-1999	26-Jun-1997	Granted
Title:	Apparatus for	Testing Circuit Bo	ards		
<u> </u>	110	C13 490 4	01 Jan 2002	07-Aug-2000	Granted
1448	US 7 Avia Pressu	6334784 re Mount Connecto	01-Jan-2002 vr Fiyture	07-Aug-2000	Graniou
Title:	L-AXIS PICSSU	re mount Connect	<u></u>		

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Case #	Country	Patent #	Issue Date	Filing Date	Status
1477 Title:	US Optical Connector F Misalignments by I	6736546 errule Designe ncorporating E:	18-May-2004 d to Minimize Mar xact Constraint Pri	16-Jul-2002 nufacturing Imper nciples	Granted fections and Mating
1481 Title:	US Electrical Solder Ba	6641410 Il Contact	04-Nov-2003	07-Jun-2001	Granted
1482 Title:	US Waferized Power Co	6592381 onnector	15-Jul-2003	25-Jan-2001	Granted
1485 Title:	EP Matrix Connector	1358697	04-May-2005	01-Feb-2002	Granted
1485	US Matrix Connector	6769935	03-Aug-2004	01-Feb-2002	Granted
1486 Title:	US High-Density Fiber	6547445 Optic Backpla	15-Apr-2003 ne	06-Feb-2001	Granted
1489 Title:	US High Speed Multi-L	6541712 ayer Printed C	01-Apr-2003 ircuit Board VIA	04-Dec-2001	Granted
1524 Title:	US Waferized Fiber Op	6769814 tic Connector	03-Aug-2004	16-Jul-2002	Granted
1615 Title:	US SELF-ALIGNING	6739918 Electrical	25-May-2004 CONNECTOR	01-Feb-2002	Granted
1617 Title:	US Methods and Appar	6839935 atus for Cleani	11-Jan-2005 ng Optical Connec	29-May-2002 ctors	Granted
1636 Title:	US Matrix Connector w	6764349 vith Integrated	20-Jul-2004 Power Contacts	29-Mar-2002	Granted
1684 Title:	US Electrical Connecto	6709294 or with Conduc	23-Mar-2004 tive Plastic Feature	17-Dec-2002 es	Granted
	US	6832858	21-Dec-2004	13-Sep-2002	Granted

Case #	Country	Patent #	Issue Date	Filing Date	Status	
1719 Title:	US Techniques for Apparatus	6762941 Connecting A Set o	13-Jul-2004 of Connecting Ele	15-Jul-2002 ments Using An	Granted Improved Latching	

r		3751077.0	10 0 1007	Crontod				
1734	DE		10-Sep-1987					
		stic Laminates for U			uit Boards and			
	Process for Making Such Laminates and Resulting Products							
1734	FR		10-Sep-1987					
		stic Laminates for U			uit Boards and			
	Process for Ma	king Such Laminate	s and Resulting P	roducts				
1734	GB	0326577	10-Sep-1987	Granted				
		stic Laminates for U			uit Boards and			
	Process for Ma	king Such Laminate	s and Resulting P	roducts				
1734	US	5037691	06-Aug-1991	23-Aug-1989				
Title:	Reinforced Pla	stic Laminates for U	se in the Producti	on of Printed Circ	uit Boards and			
		king Such Laminate						

1735JP212915810-Sep-199710-Sep-1987GrantedTitle:Printed Circuit Board Made of Reinforced Synthetic Resin Laminates

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[1736	JP		04-Oct-1995			
	Title:	Method	for Making Reinforced	Plastic Laminates for	or Use in Productio	n of Circuit Boards	
	1736	JP		25-Apr-1997			
	Title:	Method	for Making Reinforced	Plastic Laminates for	or Use in Productio	n of Circuit Boards	
	1736	US	4943334	24-Jul-1990	15-Sep-1986	Granted	
	Title:	Method	for Making Reinforced	Plastic Laminates for	or Use in Production	on of Circuit Boards	

17		US	5478421	26-Dec-1995		Granted
	Title:	Method f	for Making Composite Stru	uctures by Filame	nt Winding	

1757US678677107-Sep-200420-Dec-2002GrantedTitle:Interconnection System With Improved High Frequency Performance

	1766	US	6776645	17-Aug-2004	20-Dec-2002	Granted
	Title:	LATCH AND RELE	EASE SYSTEM	FOR A CONNEC	CTOR	

1778 Title	US High Speed, I	6776659 High Density Electric	17-Aug-2004 cal Connector	26-Jun-2003	Granted	
1806	US	6827611	07-Dec-2004	18-Jun-2003	Granted	

 1806
 US
 6827611
 07-Dec-2004
 18-Jun-2003

 Title:
 Electrical Connector with Multi-Beam Contact

Case #	Country	Patent #	Issue Date	Filing Date	Status	
1824	US	6814619	09-Nov-2004	26-Jun-2003	Granted	
	High Speed, Hig	h Density Electric	al Connector And	Connector Assen	nbly	
1825	US High Speed, Hig	6780059	24-Aug-2004	26-Jun-2003	Granted	

1849	US		29-Mar-2005	29-Sep-2003	
Title:	HIGH SPEED,	HIGH DENSITY E	LECTRICAL CC	NNECTOR ASS	EMBLY

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Patent Applications:

Case #	Country		Filing Date	Status	
05-2021	L US			17-Jun-2005 Pend:	
Title	:	A COMPUTER SYSTEM	I FOR MODELIN	IG LOSS ACROSS A BA	CKPLANE AND
1	AN ASSO	CIATED METHOD OF USE			
L					
1011	JP	521651/96	04-Dec-1995	Published	PRINTED
Title	-				FRINIED
CIRCUL	I BOARD	CONNECTORS			
1056	JP	97/534383	06-Feb-1997	Published	
Title					
Elect	rical C	onnector Assembled From	warers		
L					·····
1091	CA	2280173	05-Aug-1999	Pending	** 1
Title	•				High
		ensity Electrical Conne	ctor	- 111 1	
1091	JP	534683/98	09-Aug-1999	Published	TT-1 orb
Title	•		1		High
	-	ensity Electrical Conne		0.C. 3	-2 / T) m fm - 44
1091	KR	1999-70071-	49	06-Aug-1999Grante	u (Fat #
517158	•				High
Title	•		-		urAn
Speed,	High D	ensity Electrical Conne	ctor		
1					

2280174 15-Jan-1998 Pending CA 1103 HIGH Title: SPEED, HIGH DENSITY ELECTRICAL CONNECTOR 534510/98 09-Aug-1999 Published JP 1103 HIGH Title: SPEED, HIGH DENSITY ELECTRICAL CONNECTOR 06-Aug-1999 Published 1999-7007150 KR 1103 HIGH Title: SPEED, HIGH DENSITY ELECTRICAL CONNECTOR

1151CA235282030-May-2001 PendingTitle:PrintedCircuit Board and Method for Fabricating Such Board1151EP99962969.402-Dec-1999 Granted (Pat # 1138180)Title:Printed

1151 JP Title:	for Fabricating Such Board 2000-586144 04-Jun-2001 Published for Fabricating Such Board	Printed
1154 EP	04000082.0 06-Jan-2004 Published	
Title: ELECTRICAL CONNECTOR 1154 JP Title: ELECTRICAL CONNECTOR	2000-584560 24-May-2001 Published	

Case #	Country		Filing Date	Status		
1220 Title	CA ;	2392322	22-May-2002 Differential	Pending Signal	Electrical	Connectors
1220 Title	CA ;	2461037	24-Nov-1999 Differential	Pending Signal	Electrical	Connectors
1220 Title	CN :	99817015.1	23-May-2002 Differential			Connectors
1220 Title	CN :	0410033454	.5 Differential		2004 Publis Electrical	
1220 Title	EP	99962856.3	24-Nov-1999 Differential	Publish Signal	ed Electrical	Connectors
1220 Title	EP	04002034.9	24-Nov-1999 Differential			Connectors
1220 Title	EP	04028406.9	01-Dec-2004 Differential			Connectors
1220 Title	JP :	2001-54089	2 23-May-2002 Differentia	Publish l Signal	ed Electrical	Connectors
1220 Title	JP 2:	2004-56190	01-Mar-2004 Differentia	Pending l Signal	I Electrical	Connectors
1220 Title	KR	2002-70066	95 Differentia		2002 Publis Electrical	
1220 Title	KR	2004 - 70083	53 Differentia		-2004 Pendi Electrical	

3996376v2

1220 Title:	МХ	2002/005163 24-Nov-1999 Pending Differential Signal Electrical Connector
1220 Title:	МХ	2004/003001 24-Nov-1999 Pending Differential Signal Electrical Connector
1221	CA	2377396 21-Jun-2000 Pending
Title:	~** I	Modular Electrical Connector and Connector Syste
1221 11/30/05)	EP	00943009.1 21-Jun-2000 Published (Will grant on
Title:		Modular Electrical Connector and Connector Syste
		2000-584561 24-May-2001 Published
1227 Title:	υr	Electrical Connector with Impedance Balancing Section
1325 Title:	JP	2001-557119 05-Aug-2002 Pending Differential Signal Electrical Connecto
1326	JP EP	Differential Signal Electrical Connecto 03029590.1 23-Dec-2003 Published
Title:		Differential Signal Electrical Connecto

Case # Co	ountry		Filing	Date	Status		
1327 Title:	CA	2399960			Pending CTOR WITH	EGG-CRATE	SHIELDING
1327 Title:	CN	01804535.9	05-Aug			EGG-CRATE	SHIELDING
1327 Title:	IL	151055	01-Aug		Pending CTOR WITH	EGG-CRATE	SHIELDING

1327 Title:	JP	2001-557116 05-Aug	9-2002 Pending CONNECTOR WITH EGG-CRATE SHIELDING
1327 Title:	KR	2002-7010001	02-Aug-2002 Published CONNECTOR WITH EGG-CRATE SHIELDING
1327 Title:	мх	2002/007546 05-Aug	J-2002 Pending CONNECTOR WITH EGG-CRATE SHIELDING

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1394 CA		2431346	16-Jun-2003 Pending	
Title:				Methods
and Apparatus	for		to An Optical Interface	
1394 CN		01821104.6	19-Dec-2001 Published	
Title:				Methods
and Apparatus	for	Controlling Access	to An Optical Interface	
1394 EP		00991358.1	19-Dec-2001 Pending	
Title:				Methods
and Apparatus	for	Controlling Access	to An Optical Interface	
1394 JP		2002-551629	17-Jun-2003 Published	
Title:				Methods
and Apparatus	for	Controlling Access	to An Optical Interface	
1394 MX			19-Dec-2001 Published	
Title:				Methods
and Apparatus	for	Controlling Access	to An Optical Interface	
* 4		-		

1405	CN		01813871.3	08-Feb-2003	Published
Title:					
Electro	-Optic	Connector			
1405	EP		01952858.7	20-Jul-2001	Published
Title:					
Electro	-Optic	Connector			
1405	JP		2002-517268	07-Feb-2003	Published
Title:					
Electro	-Optic	Connector	Module		

1410JP2002-561992 30-Jan-2002 PublishedTitle:Techniques for Selectively Exposing and Protecting An Optical InterfaceUsing Film1410MX2003/006844 31-Jul-2003 PublishedTitle:Techniques for Selectively Exposing and Protecting An Optical InterfaceUsing Film

1437 CA

2435759

23-Jan-2002 Pending

Title: Connector Molding Method and Shielded Waferized Connector Made Therefrom 02804171.2 25-Jan-2002 Published CN 1437 Title: Connector Molding Method and Shielded Waferized Connector Made Therefrom 02720835.4 23-Jan-2002 Published EP 1437 Title: Connector Molding Method and Shielded Waferized Connector Made Therefrom 2002-560236 23-Jan-2002 Published JP 1437 Title: Connector Molding Method and Shielded Waferized Connector Made Therefrom 2003/006690 25-Jul-2003 Published 1437 MX Title: Connector Molding Method and Shielded Waferized Connector Made Therefrom

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Status **Filing Date** Case # Country 29-Aug-2002 Pending 1477 CA 2469301 Optical Title: Connector Ferrule Designed to Minimize Manufacturing Imperfections and Mating Misalignments by Incorporating Exact Constraint Principles 02821606.7 29-Aug-2002 Pending 1477 CN Optical Title: Connector Ferrule Designed to Minimize Manufacturing Imperfections and Mating Misalignments by Incorporating Exact Constraint Principles 02766158.6 29-Aug-2002 Published ΕP 1477 Optical Title: Connector Ferrule Designed to Minimize Manufacturing Imperfections and Mating Misalignments by Incorporating Exact Constraint Principles 2003-525350 01-Mar-2004 Pending JP 1477 Optical Title: Connector Ferrule Designed to Minimize Manufacturing Imperfections and Mating Misalignments by Incorporating Exact Constraint Principles

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02804169.0 23-Jan-2002 Pending
1482
         CN
 Title:
 Waferized Power Connector
                          02705906.2 23-Jan-2002 Pending
1482
         ΕP
 Title:
 Waferized Power Connector
                          2002-560238 23-Jan-2002 Published
         JP
1482
 Title:
 Waferized Power Connector
                          2003/006691 25-Jul-2003 Published
1482
         MX
 Title:
 Waferized Power Connector
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1485CN02805724.401-Feb-2002PublishedTitle:MatrixConnector

1485	JP	2002-561325 01-Feb-2002 Published	Matrix
Title:			
Connect	or		
1485	MX	2003/006895 01-Feb-2002 Pending	
Title:			Matrix
Connect	or		

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02804622.6 05-Feb-2002 Pending CN1486 High-Title: Density Fiber Optic Backplane 02702147.6 05-Feb-2002 Pending 1486 EP High-Title: Density Fiber Optic Backplane 2002-563051 05-Feb-2002 Published JP 1486 High-Title: Density Fiber Optic Backplane

1489TW9113502003-Dec-2002 PublishedTitle:HighSpeed Multi-Layer Printed Circuit Board VIA

29-Aug-2002 Pending 2455903 1524 CA Title: Waferized Fiber Optic Connector 02816889.5 27-Feb-2004 Published 1524 CN Title: Waferized Fiber Optic Connector 02768756.5 29-Aug-2002 Published EP 1524 Title: Waferized Fiber Optic Connector

Case # CountryFiling DateStatus1524JP2003-525351 27-Feb-2004PublishedTitle:
Waferized Fiber Optic Connector2004-700296727-Feb-20041524KR2004-700296727-Feb-2004Title:
Waferized Fiber Optic Connector

1618 Title:	EP	03814958-9 24-Dec-2003 Published System and Method for Inspecting an Optical Interface
1618 Title:	US	10/329881 26-Dec-2002 Published System and Method for Inspecting an Optical Interface

1636 Title:	CN		03800362.7	01-Dec-2003	Published	Matrix
	with	Integrated	Power Contac	cts		
	EP		03716816.8		Published	
Title:						Matrix
Connector	with		Power Contac			
1636	JP		2003-582862	29-Sep-2004	Pending	
Title:						Matrix
Connector	with	Integrated	Power Contac	cts		

1684EP03814022.417-Dec-2003 PublishedTitle:Electrical Connector with Conductive Plastic Features

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1693EP03814856.518-Dec-2003 PublishedTitle:Systems and Methods for Inspection An Optical Interface1693US10/32988126-Dec-2002 PendingTitle:Systems and Methods for Inspection An Optical Interface

03821632.9 11-Mar-2005 Published 1719 CN Techniques for Connecting A Set of Connecting Elements Using An Title: Improved Latching Apparatus 03764595.9 15-Jul-2003 Published ΕP 1719 Techniques for Connecting A Set of Connecting Elements Using An Title: Improved Latching Apparatus 2004-521766 11-Mar-2005 Pending 1719 JP Techniques for Connecting A Set of Connecting Elements Using An Title: Improved Latching Apparatus

1721	CA	2459290	29-Aug-2002 Pending	
Title	:			Modular
Fiber	Optic Connec	tion System		

Case #	Country		Filing Date	Status	
1721 Title	CN	02819348.2	31-Mar-2004	Published	Modular
Fiber 1721 Title	Optic Connection EP		29-Aug-2002	Published	Modular
Fiber 1721 Title	Optic Connection JP		01-Mar-2004	Pending	Modular
Fiber 1721 Title	Optic Connection US		16-Jul-2002	Published	Modular
Fiber	Optic Connection	System			

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1742EP03800022.020-Dec-2003PendingTitle:FERRULE ASSEMBLY AND METHODSTHEREFOR1742US10/32481620-Dec-2002PublishedTitle:FERRULE ASSEMBLY AND METHODSTHEREFOR

1757EP03814231.120-Dec-2003 PendingTitle:Interconnection System With Improved High Frequency Performance

 1769	US	10/952103	28-Sep-2004 Pending
Title:			Star Routed Backplane
1769	WO	US05/34494	26-Sep-2005 Pending
Title:	Star	Routed Backplane	

1772EP03783463.713-Nov-2003PublishedTitle:CONNECTOR AND PRINTED CIRCUIT BOARD FOR REDUCING CROSS-TALK

1774	US		10/422515	24-Apr	-2003 Pending	J			
Title:									Printed
Circuit	Board	Minimizing	Undesirable	Signal	Reflections	in a	Via	and	
M	ethods	Therefor							
1774	WO		US04/012704	23-Apr	-2004 Publish	ned			
Title:									Printed
Circuit	Board	Minimizing	Undesirable	Signal	Reflections	in a	ı Via	and	
М	ethods	Therefor							
L									

1783 Title:	US	10/954865	30-Sep-2004 Pending Perpendicular Switch Card Architecture
1783	WO		28-Sep-2005 Pending
Title:	Perpendicular		Architecture

26-Sep-2003 Published 10/672779 1788 ΰS Protective Covers for Fiber Optic Connector Title: 03-Sep-2003 Published 10/675647 1811 US High Title: Speed, High Density Electrical Connector US04/028956 03-Sep-2004 Published 1811 WO High Title: Speed, High Density Electrical Connector

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Case #CountryFiling DateStatus1815US60/67521727-Apr-2005PendingTitle:Discharging Energy During Hot Plugging for Power Using ConductivePlastic

 1819
 US
 60/639064
 23-Dec-2004 Pending

 Title:
 BARE DIE SOCKET

 1819
 US
 11/053448
 08-Feb-2005 Pending

 Title:
 BARE DIE SOCKET

1821 Title:	US	60/63	9041 23		Pending ONMENTALLY	SEALED	CHIP	SOCKET
1821 Tit	US le:	11/05 ENVIRONMENTALLY SE	9492 08 ALED CHIE		Pending			

1824 WO US04/020170 23-Jun-2004 Published Title: High Speed, High Density Electrical Connector And Connector Assembly 1825 WO US04/020109 23-Jun-2004 Published Title: High Speed, High Density Electrical Connector

10/603048 24-Jun-2003 Published 1826 US Printed Title: Circuit Board For High Speed, High Density Electrical Connector With Improved Cross-Talk Minimization, Attenuation And Impedance Mismatch Characteristics US04/19846 23-Jun-2004 Published 1826 WO Printed Title: Circuit Board For High Speed, High Density Electrical Connector With Improved Cross-Talk Minimization, Attenuation And Impedance Mismatch Characteristics

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TIS

10/744328 23-Dec-2003 Pending

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Title	3:				HIGH
SPEED	CONNECTOR	ASSE			
 1840	WO			US04/039063 19-Nov-2004 Pending	
ני	itle:	HIGH	SPEED	CONNECTOR ASSEMBLY	

 1855
 US
 10/741542
 23-Dec-2003 Pending

 Title:
 Modular Rackmount Chiller

 1855
 WO
 US04/041964
 13-Dec-2004 Pending

 Title:
 Modular Rackmount Chiller

1856US10/77405023-Dec-2003PendingTitle:Modular Fiber Optic Connection System

1857US10/74547523-Dec-2003 PendingTitle:Fiber Optic Adapter Designed To Accommodate Different Style Ferrules

Case # Country	Filing Date Status
1874 US	10/886449 07-Jul-2004 Pending
Title:	Atmospheric 2-Phase Electronics Cooling System

1882	US	11/115874 27-Apr-2005 Pending	
Title:		Layer count reduction in backplane PCF	3

1886	US	10/882598	01-Jul-2004 Pending
Title:			Orthogonal optical edge connector
1886	WO	US05/22487	24-Jun-2005 Pending
Title:			Orthogonal optical edge connector

1891 U	S	10/874837	23-Jun-2004 Pending
	l Connector		Passive Circuit Elements 3 23-Jun-2005 Pending
Title: Electrica	l Connector	Incorporating	Passive Circuit Elements

1892US10/87466923-Jun-2004 PendingTitle:Methodsof Manufacturing An Electrical Connector Incorporating Passive Circuit

Elements

Γ	1898	US			1	0/959652	06-Oct-2004	Pending
	Title:	GbX	1.85mm	х	1.85	mid-plane	x-connect	
	1898	WO			U	S05/	06-Oct-2005	Pending
	Title:	GbX	1.85mm	х	1.85	mid-plane	x-connect	

10/881248 30-Jun-2004 Pending 1902 US Connector System for Optical Wave Guides Title: 24-Jun-2005 Pending TBD 1902 WO Connector System for Optical Wave Guides Title:

1.1

10/897638 23-Jul-2004 Pending US 1903 Microwave Quality Reflect Standard To Improve In-Fixture Calibration Title: US05/026075 22-Jul-2005 Pending 1903 WO Title: Microwave Quality Reflect Standard To Improve In-Fixture Calibration

60/638973 24-Dec-2004 Pending US 1913 Title: MIDPLANE ESPECIALLY APPLICABLE TO AN ORTHOGONAL ARCHITECTURE ELECTRONIC SYSTEM 11/173927 01-Jul-2005 Pending US 1913 Title: MIDPLANE ESPECIALLY APPLICABLE TO AN ORTHOGONAL ARCHITECTURE ELECTRONIC SYSTEM

Case # Country

Filing Date Status

1915	US	10/954441	30-Sep-2004	Pending		
Title:						Modular
Cooling S	Shelf					
1915	WO	US05/34596	28-Sep-2005	Pending		
Title	: Modular	Cooling Shelf				
1918	US	10/955571	30-Sep-2004	Pending		
Title:	05		Speed, High		Electrical	Connector
1918	WO	US05/34605	28-Sep-2005	Pending		
Title:	High Spee	d, High Density El	ectrical Con	nector		,
1943	US	60/638971	24-Dec-2004	Pending		
Title:		·				

PATENT REEL: 024932 FRAME: 0893 DIFFERENTIAL ELECTRICAL CONNECTOR ASSEMBLY 1943 US 11/173926 01-Jul-2005 Pending Title: DIFFERENTIAL ELECTRICAL CONNECTOR ASSEMBLY

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1952	US		14-Dec-2004 Pending	
Title:		Front-To-Back Air	Cooling Architecture	For Orthogonal Board
Architec	tures			
				·
1973	US	11/220382		
Title:		Bi-D	irectional Electrical	Path for Contact End
05 0010	US	60/695705	30-Jun-2005 Pending	
05-2019 Title:	05	007055705	50 Guit 2005 Ferretrig	TRIPOLI
05-2019	US	11/183564	18-Jul-2005 Pending	
Title:				TRIPOLI
05-2028	US	60/695264	30-Jun-2005 Pending	CONDUCTIVE INSERTS
Title:				
05-2029	US	60/695308	30-Jun-2005 Pending	
Title:	00			FIAL SIGNAL CONDUCTORS

Patent Disclosures:

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Case No	Statu	s Title
05-2036	Open	EXTRACTION OF PHYSICALLY CONSISTENT, FREQUENCY-DEPENDENT DIELECTRIC PROPERTIES OF PCB TRANSMISSION LINES
05-2037	Open	LOSSY MATERIAL DISPOSED BETWEEN DIFFERENTIAL PAIRS OF SIGNAL CONDUCTORS IN AN INTERCONNECTION DEVICE
05-2040	Open	THICK FILM RESISTORS AND OTHER COMPONENTS INTEGRATED INTO A CONNECTOR
1919	Open	MATCHED IMPEDANCE PLATED THROUGH HOLE FOR THE INTERCONNECTION OF TWO CONNECTORS
1976	Open	STIFFENER-ORGANIZER FOR CONNECTOR TO IMPROVE WAFER POSITIONING & ATTACHMENT REFLOW
05-2002	Aut	horized SMT PIN WITH NOTCH/DIMPLE FOR SOLDERING AND ADHESIVE ATTACHMENT [Note: Awaiting Inventor signatures - will be filed as US provisional application on November 30, 2005 if inventors have not responded]
05-2003		Authorized FOLDED-DISK PIN FOR SMT SOLDER AND/OR COMPOUND ATTACHMENT [Note: Awaiting Inventor signatures - will be filed as US provisional application on November 30, 2005 if inventors have not responded]

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Patent Disclosures:

Case No	Status	Title
05-2036	Open	EXTRACTION OF PHYSICALLY CONSISTENT, FREQUENCY-DEPENDENT DIELECTRIC PROPERTIES OF PCB TRANSMISSION LINES
05-2037	Open	LOSSY MATERIAL DISPOSED BETWEEN DIFFERENTIAL PAIRS OF SIGNAL CONDUCTORS IN AN INTERCONNECTION DEVICE
05-2040	Open	THICK FILM RESISTORS AND OTHER COMPONENTS INTEGRATED INTO A CONNECTOR
1919	Open	MATCHED IMPEDANCE PLATED THROUGH HOLE FOR THE INTERCONNECTION OF TWO CONNECTORS
1976	Open	STIFFENER-ORGANIZER FOR CONNECTOR TO IMPROVE WAFER POSITIONING & ATTACHMENT REFLOW
05-2002	Authorized	SMT PIN WITH NOTCH/DIMPLE FOR SOLDERING AND ADHESIVE ATTACHMENT
05-2003	Authorized	FOLDED-DISK PIN FOR SMT SOLDER AND/OR COMPOUND ATTACHMENT

Trademarks:

Mark	Class	Serial No.	Filing Date	Registration Number.	Registration Date	Status
CROSSBOW	IC 009	78682550	August 1, 2005	N/A	N/A	Pending
VENTURA	IC 009	78418881	May 14, 2004	N/A	N/A	Pending
APTERA	IC 009	78514820	November 10, 2004	N/A	N/A	Pending
DIFFERENTIAL CLEARANCE TECHNOLOGY	IC 009	78297381	September 8, 2003	N/A	N/A	Pending
NEXLEV	IC 009	78107484	February 7, 2002	2669292	December 31, 2002	Registered
GBX	IC 009	76474185	December 12, 2002	2779372	November 4, 2003	Registered
BRINGING BANDWIDTH TO THE GLOBAL NETWORK	IC 009	75862605	December 2, 1999	2426683	February 6, 2001	Registered
VHDM	IC 009	75383873	November 3, 1997	2423664	January 23, 2001	Registered
HDM PLUS	IC 009	74350016	January 21, 1993	1894556	May 16, 1995	Registered
HDM	IC 009	74353156	January 21, 1993	1886552	March 28, 1995	Registered
HIGH DENSITY PLUS (HD+)	IC 009	73688734	October 9, 1987	1494014	June 28, 1988	Registered

Service Marks:

Mark	Class	Serial No.	Filing Date	Registration Number	Registration Date	Status
DESIGNLINK	IC 042	78470448	August 19, 2004	N/A	N/A	Pending

SCHEDULE B

Intellectual Property Licensed from Buyer to Assignor

Granted Patents Re: DCT Technology

	Case #	Country	Patent #	Issue Date	Filing Date	Status	
ſ	1220	US D3	6607402	19-Aug-2003	08-Apr-2002	Granted	
	Title:	Differential Sign	nal Electrical Conn	ectors			

Patent Applications Re: DCT Technology

Case #	Country		Filing Date	Status	
1220	CA	2392322	22-May-2002	Pending	
Title:	Differential Signal Electric	al Connectors			
1220	CN	0410033454.5	08-Apr-2004	Published	
Title:	Differential Signal Electric	al Connectors			
1220 -	EP	04028406.9	01-Dec-2004	Published	
Title:	Differential Signal Electric	al Connectors			
1220	JP	2004-56190	01-Mar-2004	Pending	
Title:	Differential Signal Electric	al Connectors			
1220	KR	2004-7008353	31-May-2004	Pending	
Title:	Differential Signal Electric	al Connectors			
1220	MX	2004/003001	24-Nov-1999	Pending	
Title:	Differential Signal Electric	al Connectors			

Patent Applications Re: DESIGNLINK

Case #	Country		Filing Date	Status	
05-2021	US	60/691423	17-Jun-2005	Pending	
Title:	A COMPUTER	SYSTEM FOR MODELING	J LOSS ACROSS	A BACKPLANE A	ND
	AN ASSOCIA ⁻	TED METHOD OF USE			

SCHEDULE C

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Trademarks Licensed from Assignor to Buyer Subject to Certain Conditions

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RECORDED: 09/02/2010

PATENT REEL: 024932 FRAME: 0899